



# 50 MHz to 4000 MHz ACTIVE BIAS SILICON GERMANIUM CASCADABLE GAIN BLOCK

Package: SOT-363

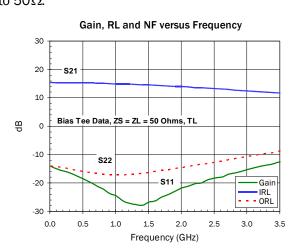




**Product Description** 

RFMD's SGC4263Z is a high performance SiGe HBT MMIC amplifier utilizing a Darlington configuration with a patented active bias network. The active bias network provides stable current over temperature and process Beta variations. Designed to run directly from a 3V supply, the SGC4263Z does not require a dropping resistor as compared to typical Darlington amplifiers. The SGC4263Z is designed for high linearity 3V gain block applications that require small size and minimal external components. It is internally matched to  $50\,\Omega$ .





#### **Features**

- Single Fixed 3V Supply
- No Dropping Resistor Required
- Patented Self-Bias Circuitry
- P<sub>1dB</sub>=15.1dBm at 1950MHz
- $\bullet$  OIP<sub>3</sub>=30dBm at 1950MHz
- Robust 1000V ESD, Class 1C HBM

### **Applications**

- PA Driver Amplifier
- Cellular, PCS, GSM, UMTS, WCDMA
- IF Amplifier
- Wireless Data, Satellite

Dougnastor	Specification			Lloit	Open disting		
Parameter	Min.	Тур.	Max.	Unit	Condition		
Small Signal Gain, (G)		15.0		dB	500MHz		
	13.2	14.7	16.2	dB	*850MHz		
	12.6	14.0	15.4	dB	1950MHz		
Output Power at 1dB Compression (P <sub>1dB</sub> )		15.2		dBm	500 MHz		
		15.1		dBm	850MHz		
	13.6	15.1		dBm	1950MHz		
Output Third Order Intercept Point (OIP <sub>3</sub> )		32.0		dBm	500 MHz		
		30.5		dBm	850MHz		
	27.0	30.0		dBm	1950MHz		
Input Return Loss, (IRL)	17.0	23.5		dB	1950MHz		
Output Return Loss, (ORL)	17.0	21.0		dB	1950MHz		
Noise Figure (NF)		3.3	4.5	dB	1930MHz		
Device Operating Voltage, (V <sub>D</sub> )		3.0		V			
Device Operating Current, (I <sub>D</sub> )	47	55	63	mA			
Thermal Resistance		130		°C/W	(Junction - Lead) (Rth, j-l)		

Test Conditions:  $V_D$ =3V,  $I_D$ =55mA Typ.,  $T_L$ =25°C,  $OIP_3$  Tone Spacing=1MHz. \*Bias Tee Data,  $Z_S$ = $Z_L$ =50 $\Omega$ ,  $P_{OUT}$  per tone=0dBm, Application Circuit Data Unless Otherwise Noted



#### **Absolute Maximum Ratings**

Parameter	Rating	Unit
Max Device Current (I <sub>D</sub> )	110	mA
Max Device Voltage (V <sub>D</sub> )	4	V
Max RF Input Power <sup>1</sup>	12	dBm
Max RF Input Power <sup>2</sup>	18	dBm
Max Junction Temp (T <sub>J</sub> )	+150	°C
Operating Temp Range (T <sub>L</sub> )	-40 to +85	°C
Max Storage Temp	+150	°C
ESD Rating - Human Body Model (HBM)	Class 1C	
Moisture Sensitivity Level	MSL 1	



1. Load condition: VSWR  $\leq$  10:1;  $V_{CC} \leq$  3.5 V 2. Load condition: VSWR  $\leq$  3:1;  $V_{CC} \leq$  3.2 V

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one. Bias Conditions should also satisfy the following expression:  $I_DV_D < (T_J - T_L) / R_{TH}, j - I \text{ and } T_L = \text{Source Lead Temperature}$ 

#### Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions to the device may reduce the device under Absolute Maximum Rating conditions to the device may reduce the device under Absolute Maximum Rating conditions to the device under Absolute Maximum Rating co

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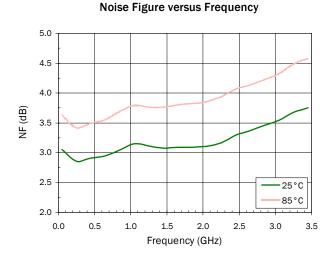
RFMD Green; RoHS compliant per EU Directive 2002/95/EC, halogen free per IEC 61249-2-21, < 1000 ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony in

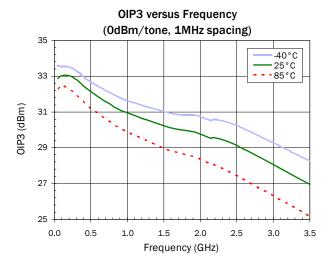
Typical RF Performance with Application Circuit at Key Operating Frequencies (App Circuit Data Unless Noted Otherwise)

Parameter	Unit	*100	500	850	1950	2500	*3500
		MHz	MHz	MHz	MHz	MHz	MHz
Small Signal Gain (G)	dB	15.4	15.0	14.7	14.0	13.1	11.6
Output Third Order Intercept Point (OIP <sub>3</sub> )	dBm	33.0	32.0	30.5	30.0	29.5	27.0
Output Power at 1dB Compression (P <sub>1dB</sub> )	dBm	15.4	15.2	15.1	15.1	15.3	14.3
Input Return Loss (IRL)	dB	14.5	16.0	21.5	23.5	16.0	13.0
Output Return Loss (ORL)	dB	13.5	13.5	17.0	21.0	20.5	9.0
Reverse Isolation (S <sub>12</sub> )	dB	18.5	19.0	19.5	19.5	19.5	18.5
Noise Figure (NF)	dB	2.8	3.2	3.1	3.3	3.5	3.8

Test Conditions:  $V_D = 3V$ ,  $I_D = 55$  mA Typ.  $OIP_3$  Tone Spacing = 1MHz,  $P_{OUT}$  per tone = 0dBm,  $T_L = 25$  °C,  $Z_S = Z_L = 50\Omega$ , \*Bias Tee Data

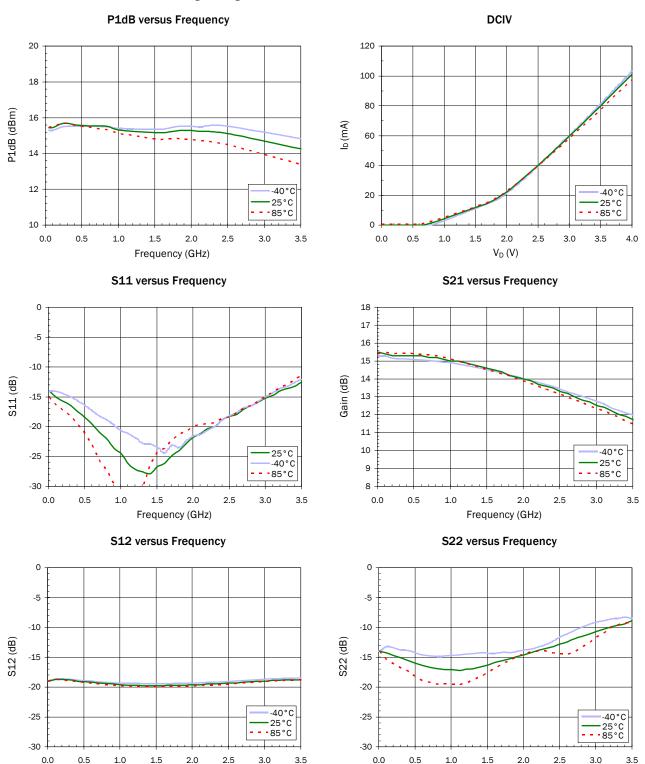
#### Typical Performance with Bias Tee, V<sub>D</sub>=3V, I<sub>D</sub>=55mA







#### Typical Performance with Bias Tee, $V_D=3V$ , $I_D=55mA$

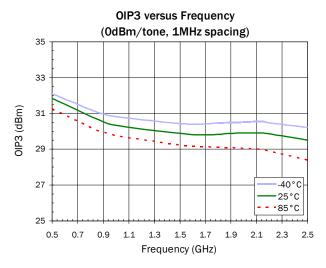


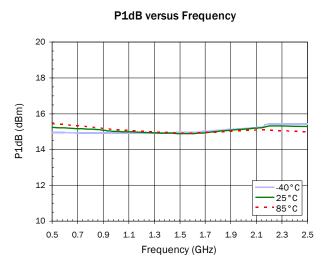
Frequency (GHz)

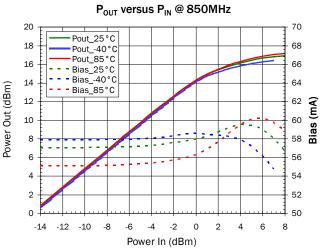
Frequency (GHz)

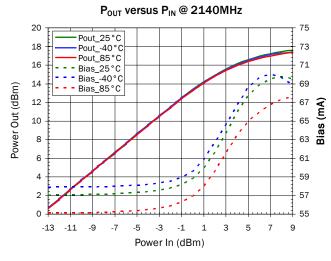


#### Typical Performance with Application Circuit, V<sub>D</sub>=3V, I<sub>D</sub>=55mA

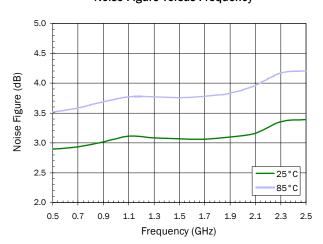








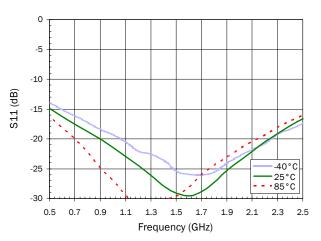
#### Noise Figure versus Frequency



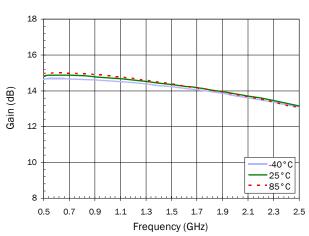




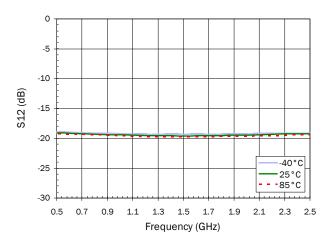




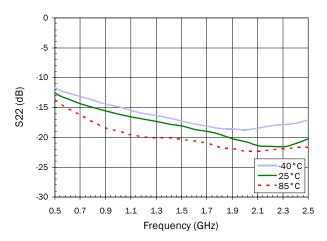
#### S21 versus Frequency



#### S12 versus Frequency



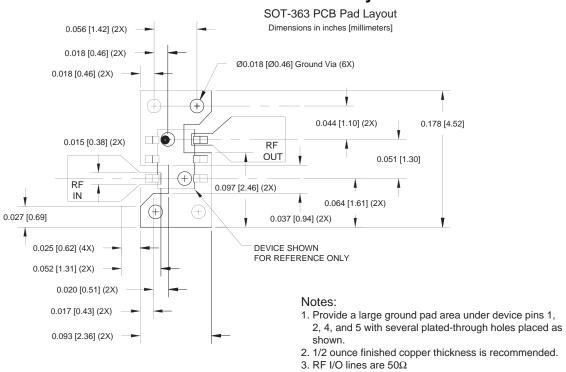
#### S22 versus Frequency





Pin	Function	Description
3	RF IN	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.
1,2,4, 5	GND	Connection to ground. Use via holes as close to the device ground leads as possible to reduce ground inductance and achieve optimum RF performance.
6	RF OUT/ DC BIAS	RF output and bias pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.

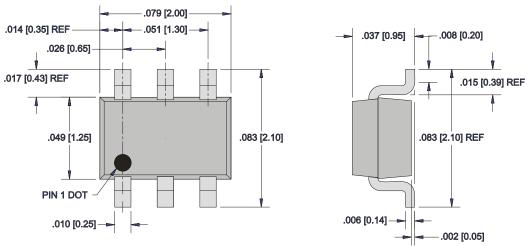
## **SOT-363 PCB Pad Layout**



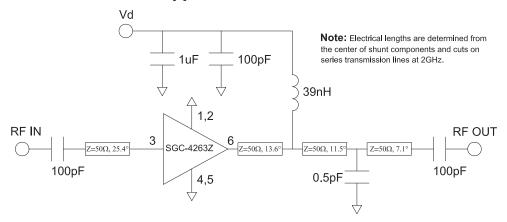


## **Package Drawing**

Dimensions in inches (millimeters)
Refer to drawing posted at www.rfmd.com for tolerances.



## **Application Schematic**





#### **Evaluation Board Layout** GND 3V 0 0 0 0 00000 0 0 .1uF0 100pF○ 0 000 00000 00000 100pF [ 0 0 0 0 0 0 0 0 0 0.5pF 0 0 0 0 0 0 0 0 0 0000 0000 0 000

PCB Assy. 800 to 2200 MHz

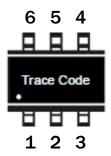
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SOT-363



## **Part Identification Marking**



## **Ordering Information**

Ordering Code	Description
SGC4263Z	7" Reel with 3000 pieces
SGC4263ZSQ	Sample bag with 25 pieces
SGC4263ZSR	7" Reel with 100 pieces
SGC4263ZPCK	800 MHz to 2200 MHz PCBA with 5-piece sample bag